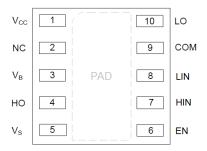


Marking Information



DGD05473 = Product Type Marking Code YY = Year (ex: 21 = 2021) WW = Week (01 to 53)

Pin Assignments



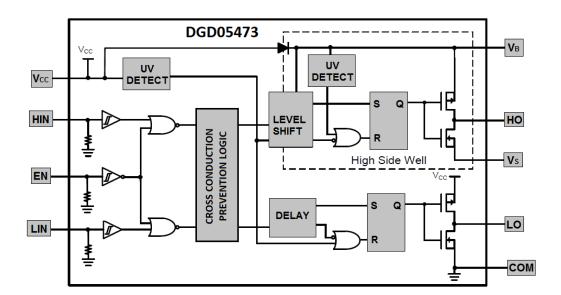
Top View: V-DFN3030-10

Pin Descriptions

Pin Number	Pin Name	Function
1	Vcc	Low-Side and Logic Supply
2	NC	No Connect (No Internal Connection)
3	V _B	High-Side Floating Supply
4	НО	High-Side Gate Drive Output
5	Vs	High-Side Floating Supply Return
6	EN	Logic Input Enable, a Logic Low turns off Gate Driver
7	HIN	Logic Input for High-Side Gate Driver, in Phase with HO
8	LIN	Logic Input for Low-Side Gate Driver, in Phase with LO
9	COM	Low-Side and Logic Return
10	LO	Low-Side Gate Drive Output
PAD	Substrate	Connect to COM on PCB



Functional Block Diagram





Absolute Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Positive Supply Voltage	V _B	-0.3 to +60	V
High-Side Floating Negative Supply Voltage	Vs	V _B -14 to V _B +0.3	٧
High-Side Floating Output Voltage	V _{HO}	V _S -0.3 to V _B +0.3	V
Offset Supply Voltage Transient	dV _S / dt	50	V/ns
Logic and Low-Side Fixed Supply Voltage	V _{CC}	-0.3 to +14	V
Low-Side Output Voltage	V_{LO}	-0.3 to V _{CC} +0.3	V
Logic Input Voltage (HIN, LIN and EN)	V _{IN}	-0.3 to V _{CC} +0.3	V
Bootstrap Diode Current (Pulsed <10μs)	I _{BD}	1	А

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	P _D	0.4	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	64	°C/W
Thermal Resistance, Junction to Case (Note 5)	Rejc	42	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	T _{STG}	-55 to +150	

5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
High-Side Floating Supply	V _B	V _S + 4.2	V _S + 14	V
High-Side Floating Supply Offset Voltage	Vs	(Note 6)	50 (Note 7)	V
High-Side Floating Output Voltage	V _{HO}	Vs	V_{B}	V
Logic and Low Side Fixed Supply Voltage	V _{CC}	4.5 (Note 8)	14	V
Low-Side Output Voltage	V_{LO}	0	V _{CC}	V
Logic Input Voltage (HIN, LIN and EN)	V _{IN}	0	5	V
Ambient Temperature	T _A	-40	+125	°C

Notes:

- 6. Logic operation for V_S of -5V to +50V. 7. Provided V_B doesn't exceed absolute maximum rating of 60V. 8. For operation of V_{CC} = 4.5V to 4.9V, an external bootstrap Schottky diode (0.3V Vfd, 1A) is necessary, see Figure 4. For operation $V_{CC} \ge 4.9V$, the external Schottky diode is not required.



Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Logic "1" Input Voltage	V _{IH}	2.4	_	_	V	_
Logic "0" Input Voltage	V _{IL}	_	_	0.8	V	_
Enable Logic "1" Input Voltage	V _{ENIH}	1.6	_	_	V	_
Enable Logic "0" Input Voltage	V_{ENIL}	_	_	0.7	V	_
Input Voltage Hysteresis	Vinhys	_	0.6	_	V	_
Enable Input Voltage Hysteresis	VENINHYS	_	0.1	_	V	_
High Level Output Voltage, V _{BIAS} - V _O	V _{OH}	_	0.45	0.6	V	I _{O+} = 100mA
Low Level Output Voltage, V _O	V _{OL}	_	0.15	0.22	V	I _{O-} = 100mA
Offset Supply Leakage Current	I _{LK}	_	1	5	μA	$V_B = V_S = 60V$
V _{CC} Shutdown Supply Current	Iccsd	_	0	1	μA	V _{IN} = 0V or 5V, V _{EN} = 0V
V _{CC} Quiescent Supply Current	Iccq	_	130	200	μA	V _{IN} = 0V or 5V
V _{CC} Operating Supply Current	I _{CCOP}	_	7.3	1	mA	fs = 500kHz, C _L = 1000pF
V _{BS} Quiescent Supply Current	I _{BSQ}	_	40	100	μA	V _{IN} = 0V or 5V
V _{BS} Operating Supply Current	I _{BSOP}	_	7.3	_	mA	fs = 500kHz. C _L = 1000pF
Logic "1" Input Bias Current	I _{IN+}	_	_	50	μA	V _{IN} = 5V
Logic "0" Input Bias Current	I _{IN-}	_	_	5	μA	V _{IN} = 0V
Enable Logic "1" Input Bias Current	I _{ENIN+}	_	43	60	μA	V _{IN} = 5V
Enable Logic "0" Input Bias Current	I _{ENIN-}	_	0	5	μA	V _{IN} = 0V
V _{BS} Supply Undervoltage Positive Going Threshold	V _{BSUV+}	3.3	3.8	4.2	V	_
V _{BS} Supply Undervoltage Negative Going Threshold	V _{BSUV} -	2.9	3.3	3.9	V	_
V _{CC} Supply Undervoltage Positive Going Threshold	V _{CCUV+}	3.3	3.8	4.2	V	_
V _{CC} Supply Undervoltage Negative Going Threshold	Vccuv-	2.9	3.3	3.9	V	_
Output High Short Circuit Pulsed Current	I _{O+}	1.0	1.5	_	Α	V _O = 0V, PW ≤ 10μs
Output Low Short Circuit Pulsed Current	l _{O-}	1.9	2.5	_	Α	V _O = 15V, PW ≤ 10μs
Forward Voltage of Bootstrap Diode	V _{F1}	_	0.67		V	I _F = 100μA
Forward Voltage of Bootstrap Diode	V_{F2}	_	1.2	_	V	I _F = 100mA

Note: 9. The V_{IN} and I_{IN} parameters are applicable to the logic pins: HIN, LIN and EN. The V_O and I_O parameters are applicable to the respective output pins: HO and LO.

$\textbf{AC Electrical Characteristics} \ (V_{CC} = V_{BS} = 12V, \ COM = V_S = 0V, \ C_L = 1000 pF, \ \textcircled{2} \ T_A = +25^{\circ}C, \ unless \ otherwise \ specified.)$

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Turn-On Propagation Delay	t _{ON}	_	20	35	ns	_
Turn-Off Propagation Delay	toff	_	23	56	ns	V _S = 50V
Delay Matching, HO & LO Turn-On	t _{DM}	_	_	5	ns	_
Turn-On Rise Time	t _r	_	16	30	ns	_
Turn-Off Fall Time	tf	_	12	25	ns	_



Timing Waveforms

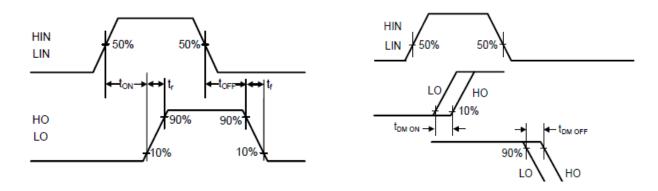


Figure 1. Switching Time Waveform Definitions

Figure 2. Delay Matching Waveform Definitions

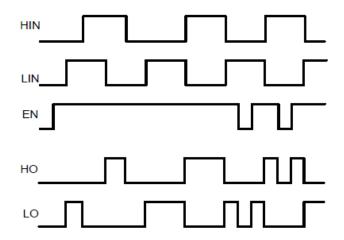


Figure 3. Input / Output Timing Diagram

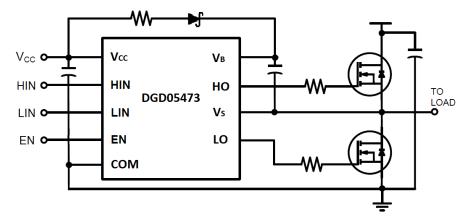


Figure 4. Typical application necessary for $V_{CC}=4.5V$ to 4.9V operation. For $V_{CC}\geq4.9V$, the bootstrap Schottky diode (0.3V Voltage drop, 1A) and resistor are not required.



Typical Performance Characteristics (V_{CC} = 12V, @ T_A = +25°C, unless otherwise specified.)

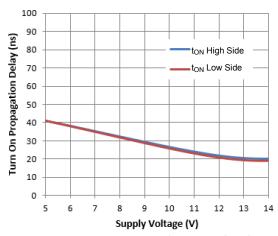


Figure 5. Turn-on Propagation Delay vs. Supply Voltage

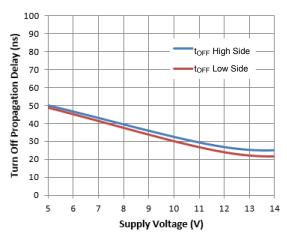


Figure 7. Turn-off Propagation Delay vs. Supply Voltage

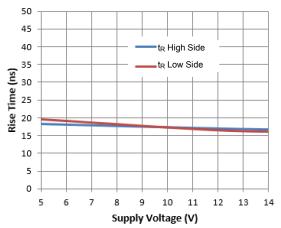


Figure 9. Rise Time vs. Supply Voltage

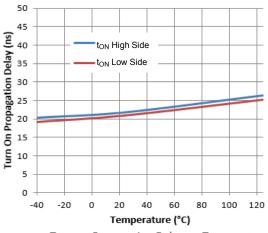


Figure 6. Turn-on Propagation Delay vs. Temperature

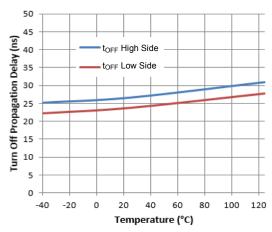


Figure 8. Turn-off Propagation Delay vs. Temperature

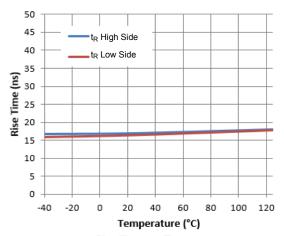


Figure 10. Rise Time vs. Temperature



Typical Performance Characteristics (continued)

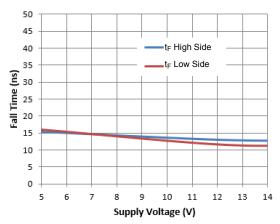


Figure 11. Fall Time vs. Supply Voltage

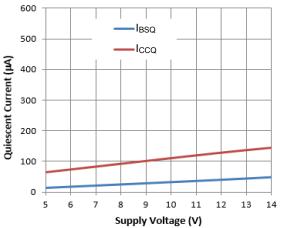


Figure 13. Quiescent Current vs. Supply Voltage

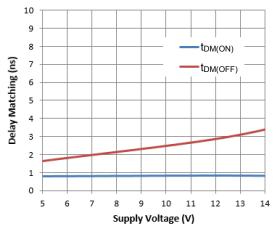


Figure 15. Delay Matching vs. Supply Voltage

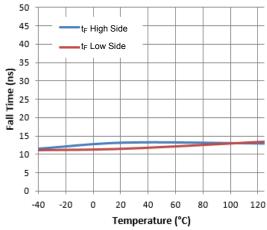


Figure 12. Fall Time vs. Temperature

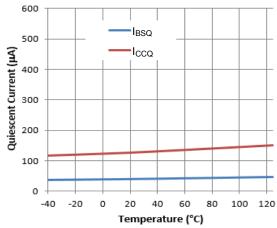


Figure 14. Quiescent Current vs. Temperature

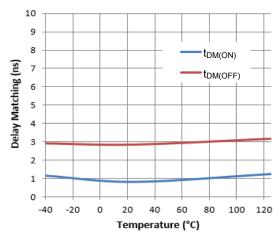


Figure 16. Delay Matching vs. Temperature



Typical Performance Characteristics (continued)

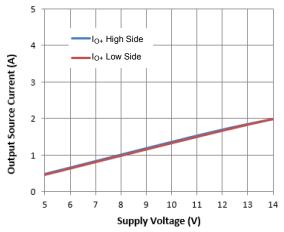


Figure 17. Output Source Current vs. Supply Voltage

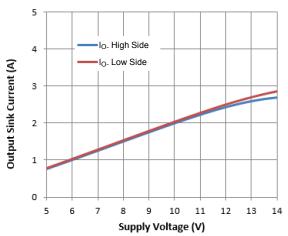


Figure 19. Output Sink Current vs. Supply Voltage

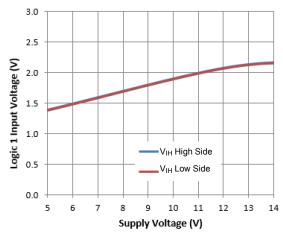


Figure 21. Logic 1 Input Voltage vs. Supply Voltage

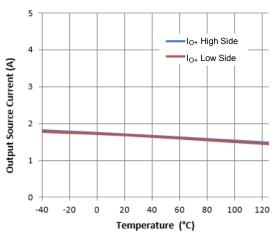


Figure 18. Output Source Current vs. Temperature

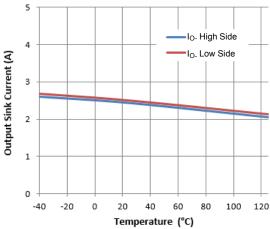


Figure 20. Output Sink Current vs. Temperature

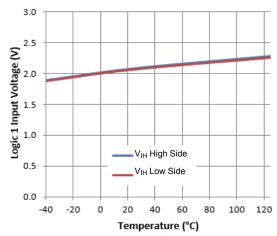


Figure 22. Logic 1 Input Voltage vs. Temperature



Typical Performance Characteristics (continued)

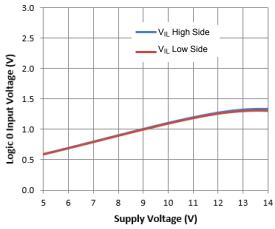


Figure 23. Logic 0 Input Voltage vs. Supply Voltage

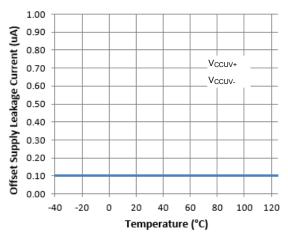


Figure 25. Offset Supply Leakage Current vs. Temperature

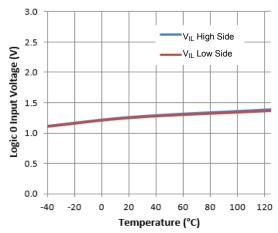
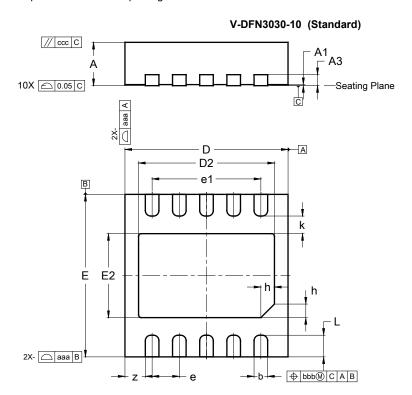


Figure 24. Logic 0 Input Voltage vs. Temperature



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

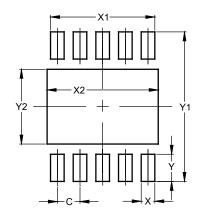


V-DFN3030-10						
(Standard)						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	0.02			
A3	1	1	0.203			
b	0.18	0.30	0.25			
D	2.90	3.10	3.00			
D2	2.40	2.60	2.50			
е	0.50BSC					
e1		2.00BS	SC SC			
Е	2.90	3.10	3.00			
E2	1.45	1.65	1.55			
h	0.20	0.30	0.25			
k	1	1	0.325			
L	0.30	0.50	0.40			
Z			0.325			
aaa	0.250					
bbb	0.100					
CCC	0.050					
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

V-DFN3030-10 (Standard)



Dimensions	Value (in mm)		
С	0.500		
Х	0.300		
X1	2.300		
X2	2.600		
Y	0.600		
Y1	3.300		
Y2	1.650		



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